

PRODUCT NUMBER

98423-X61-XXXXLF

PLATING —

S = 0.38 μ m GOLD/GXT
ON CONTACT AREA
2 μ m MIN MATTE
TIN ON TAIL

G = 0.76 μ m GOLD/GXT
ON CONTACT AREA
2 μ m MIN MATTE
TIN ON TAIL

F = GOLD FASH
ON CONTACT AREA
2µm MIN MATTE

ROHS COMPATIBLE, SEE NOTE 6
 PACKAGING OPTIONAL LETTER (SEE NOTE 5)
 NB OF POSITIONS PER ROW
 02 TO 25 POS

N x 2.00
SEE NOTE 3
(N-1) x 2.00

SEE NOIF 3

 TYP

$$4.00 \pm 0.2$$

NOTES:

1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC

UL 94V-0, COLOR BLACK

2. MATERIAL TERMINAL: COPPER ALLOY

3. TO DETERMINE DIMENSIONS:

N = NUMBER OF POSITIONS PER ROW

4. 7N MIN. PIN RETENTION IN EITHER DIRECTION.

5. PACKAGING:

= PLASTIC BOX

U = TUBE AVAILABLE FROM 06 TO 50 POS

6. ROHS COMPATIBLE PRODUCT SPECIFICATIONS

Q - PLATING:

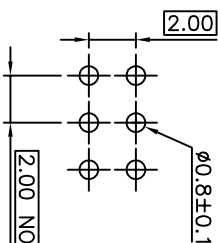
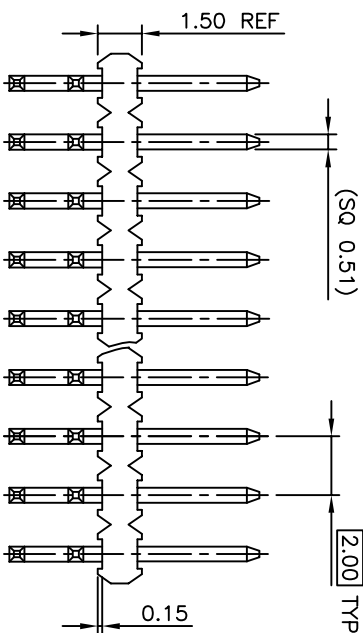
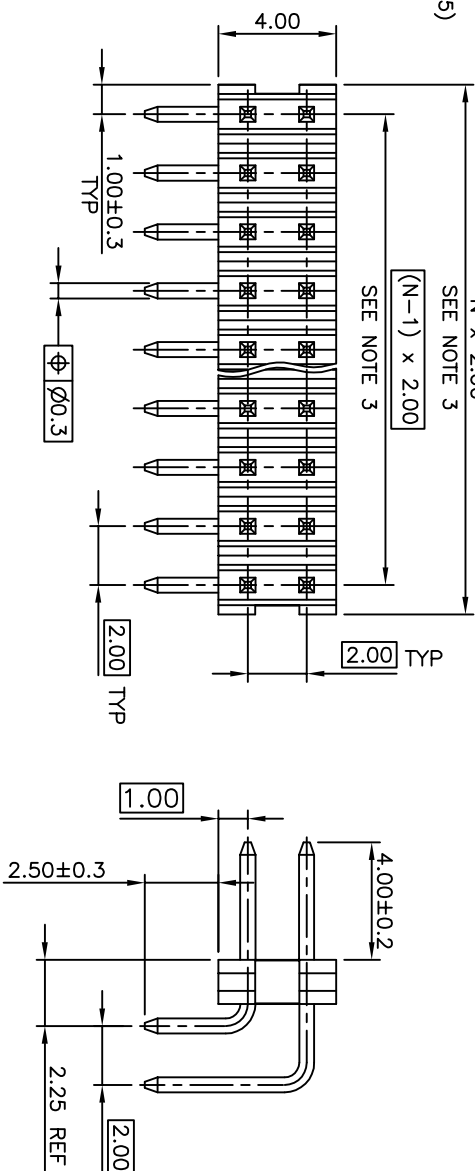
- "LF" MEANS THE PRODUCT IS LEAD-FREE,
2µm MINIMUM MATTE TIN OVER 1.27µm
MINIMUM NICKEL UNDERPLATE.

b – MANUFACTURING PROCESS COMPATIBILITY

- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C $\pm$ 5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.

C – LABELLING:

- MEETS PACKAGING SPECS AS PER GS-14-920
- d - THIS PRODUCT MEETS EUROPEAN DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DISCIBED IN GS-47-0004



RECOMMENDED HOLE PATTERN

mat'l. code						surface		tolerance		projection		product family	
						ISO 1302		☒ ISO 406		150		MINITEK	
ltr ecn no						dr		date					
A F10338 LMU						03.10.01		angles		☒ X ±0.3			
B P04-035 JCO						05.01.13		linear		X.X ±0.13			
C P06-0212 LMU						06.07.05				X.XX ±0.05			
D T08-0145 ELA						17.04.08		dr		L MLIN		04.09.28	
E B-19190 LMU						14.10.24		eng/pd		COMPAGNON		04.09.28	
								chr					
								dp/d		JM.C		04.09.28	
sheet revision													
index sheet													
												title	
												UNSHR HEADER	
												RIGHT ANGLE TMT	
dwg no												sheet 1 of 1	
98423												size A3	
Type CUSTOMER Drawing													